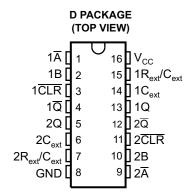
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#### **FEATURES**

- Controlled Baseline
  - One Assembly Site
  - One Test Site
  - One Fabrication Site
- Extended Temperature Performance of -55°C to 125°C
- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product-Change Notification
- Qualification Pedigree (1)
- Operating Range 2-V to 5.5-V V<sub>CC</sub>
- Schmitt-Trigger Circuitry On A, B, and CLR Inputs for Slow Input Transition Rates
- Edge Triggered From Active-High or Active-Low Gated Logic Inputs
- Retriggerable for Long Output Pulses
- (1) Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

- Overriding Clear Terminates Output Pulse
- Glitch-Free Power-Up Reset On Outputs
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)



#### **DESCRIPTION/ORDERING INFORMATION**

The SN74AHC123A device is a dual retriggerable monostable multivibrator designed for 2-V to 5.5-V  $V_{CC}$  operation.

This edge-triggered multivibrator features output pulse-duration control by three methods. In the first method, the  $\overline{A}$  input is low, and the  $\overline{A}$  input goes high. In the second method, the  $\overline{B}$  input is high, and the  $\overline{A}$  input goes low. In the third method, the  $\overline{A}$  input is low, the  $\overline{B}$  input is high, and the clear ( $\overline{CLR}$ ) input goes high.

The output pulse duration is programmed by selecting external resistance and capacitance values. The external timing capacitor must be connected between  $C_{ext}$  and  $R_{ext}/C_{ext}$  (positive) and an external resistor connected between  $R_{ext}/C_{ext}$  and  $V_{CC}$ . To obtain variable pulse durations, connect an external variable resistance between  $R_{ext}/C_{ext}$  and  $V_{CC}$ . The output pulse duration can be reduced by taking  $\overline{CLR}$  low.

Pulse triggering occurs at a particular voltage level and is not directly related to the transition time of the input pulse. The  $\overline{A}$ ,  $\overline{B}$ , and  $\overline{CLR}$  inputs have Schmitt triggers with sufficient hysteresis to handle slow input transition rates with jitter-free triggering at the outputs.

Once triggered, the basic pulse duration can be extended by retriggering the gated low-level-active  $(\overline{A})$  or high-level-active (B) input. Pulse duration can be reduced by taking  $\overline{CLR}$  low.  $\overline{CLR}$  can be used to override  $\overline{A}$  or B inputs. The input/output timing diagram illustrates pulse control by retriggering the inputs and early clearing.

The variance in output pulse duration from device to device is less than  $\pm 0.5\%$  (typ) for given external timing components. An example of this distribution for the SN74AHC123A is shown in Figure 10. Variations in output pulse duration versus supply voltage and temperature are shown in Figure 6.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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### **DESCRIPTION/ORDERING INFORMATION (CONTINUED)**

During power up, Q outputs are in the low state and  $\overline{Q}$  outputs are in the high state. The outputs are glitch free, without applying a reset pulse.

For additional application information on multivibrators, see the application report *Designing With the SN74AHC123A and SN74AHCT123A*, literature number SCLA014.

#### ORDERING INFORMATION(1)

T <sub>A</sub>	PACK	AGE <sup>(2)</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
–55°C to 125°C	SOIC - D	Tape and reel	SN74AHC123AMDREP	AHC123A-EP	

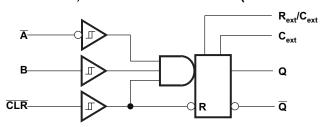
- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI Web site at www.ti.com.
- (2) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

## FUNCTION TABLE (each multivibrator)

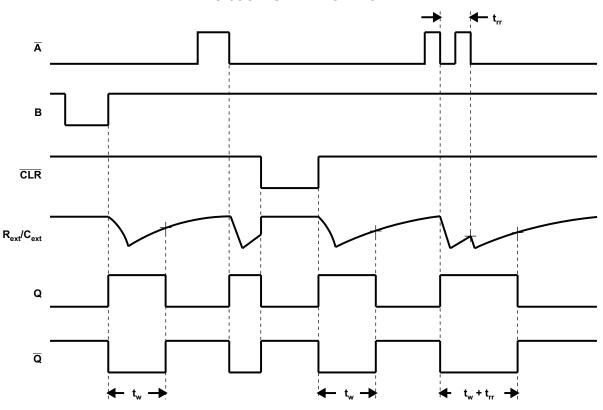
	INPUTS	OUTPUTS					
CLR	Ā	В	Q Q				
L	Х	Х	L	Н			
X	Н	X	L <sup>(1)</sup>	H <sup>(1)</sup>			
X	Χ	L	L <sup>(1)</sup>	H <sup>(1)</sup>			
Н	L	1	Л	Т			
Н	$\downarrow$	Н	Л	П			
1	L	Н	Л	П			

(1) These outputs are based on the assumption that the indicated steady-state conditions at the A and B inputs have been set up long enough to complete any pulse started before the setup.

#### LOGIC DIAGRAM, EACH MULTIVIBRATOR (POSITIVE LOGIC)



#### **INPUT/OUTPUT TIMING DIAGRAM**



## Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT		
V <sub>CC</sub>	Supply voltage range <sup>(2)</sup>		-0.5	7	V		
VI	Input voltage range (3)		-0.5	7	V		
Vo	Output voltage range in high or low sta	ate <sup>(2)</sup>	-0.5	V <sub>CC</sub> + 0.5	V		
Vo	Output voltage range in power-off state	Output voltage range in power-off state <sup>(2)</sup>					
I <sub>IK</sub>	Input clamp current	V <sub>I</sub> < 0 V		-20	mA		
I <sub>OK</sub>	Output clamp current	$V_O < 0 \text{ V or } V_O < V_{CC}$		±20	mA		
Io	Continuous output current	$V_O = 0 \text{ V to } V_{CC}$		±25	mA		
	Continuous current through V <sub>CC</sub> or GN	ID		±50	mA		
$\theta_{JA}$	Package thermal impedance (4)		73	°C/W			
T <sub>stg</sub>	Storage temperature range	Storage temperature range					

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

<sup>(2)</sup> Voltage values are with respect to the network ground terminal.

<sup>(3)</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>(4)</sup> The package thermal impedance is calculated in accordance with JESD 51-7.

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## Recommended Operating Conditions<sup>(1)</sup>

			MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage		2	5.5	V
		V <sub>CC</sub> = 2 V	1.5		
$V_{IH}$	High-level input voltage	V <sub>CC</sub> = 3 V	2.1		V
		V <sub>CC</sub> = 5.5 V	3.85		
		V <sub>CC</sub> = 2 V		0.5	
$V_{IL}$	Low-level input voltage	V <sub>CC</sub> = 3 V		0.9	V
		V <sub>CC</sub> = 5.5 V		1.65	
VI	Input voltage		0	5.5	V
Vo	Output voltage		0	$V_{CC}$	V
		V <sub>CC</sub> = 2 V		-50	μΑ
$I_{OH}$	High-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		-4	mA
		$V_{CC}$ = 5 V $\pm$ 0.5 V		-8	ША
		V <sub>CC</sub> = 2 V		50	μΑ
$I_{OL}$	Low-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		4	A
		$V_{CC} = 5 V \pm 0.5 V$		8	mA
В	External timing registeres	V <sub>CC</sub> = 2 V	5		kΩ
R <sub>ext</sub>	External timing resistance	V <sub>CC</sub> > 3 V	1		K12
$\Delta t/\Delta V_{CC}$	Power-up ramp rate		1		ms/V
T <sub>A</sub>	Operating free-air temperature		-55	125	°C

<sup>(1)</sup> Unused  $R_{ext}/C_{ext}$  terminals should be left unconnected. All remaining unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. See the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

#### **Electrical Characteristics**

over operating free-air temperature range (unless otherwise noted)

	DADAMETED	TEST CONDITIONS	V	T,	<sub>4</sub> = 25°C		MINI	MAY	LINUT	
	PARAMETER	TEST CONDITIONS	V <sub>CC</sub>	MIN	TYP	MAX	MIN	MAX	UNIT	
			2 V	1.9	2		1.9			
		$I_{OH} = -50 \mu A$	3 V	2.9	3		2.9			
$V_{OH}$			4.5 V	4.4	4.5		4.4		V	
		$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48			
		$I_{OH} = -8 \text{ mA}$	4.5 V	3.94			3.8			
			2 V			0.1		0.1		
	$I_{OL} = 50 \mu A$	3 V			0.1		0.1			
$V_{OL}$			4.5 V			0.1		0.1	V	
		I <sub>OL</sub> = 4 mA	3 V			0.36		0.44		
		$I_{OL} = 8 \text{ mA}$	4.5 V			0.36		0.44		
	R <sub>ext</sub> /C <sub>ext</sub> <sup>(1)</sup>	$V_I = V_{CC}$ or GND	5.5 V			±0.25		±2.5	^	
I <sub>I</sub>	A, B, and CLR	$V_I = V_{CC}$ or GND	0 V to 5.5 V			±0.1		±1 (2)	μΑ	
I <sub>CC</sub>	Quiescent	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			4		40	μΑ	
			3 V		160	250		280		
I <sub>CC</sub> Active state (per circuit)		$V_I = V_{CC}$ or GND, $R_{ext}/C_{ext} = 0.5 V_{CC}$	4.5 V		280	500		650	μΑ	
	(por oriodit)	rext/ Cext - 0.5 VCC	5.5 V		360	750		975		
Ci		$V_I = V_{CC}$ or GND	5 V		1.9	10		10	pF	

<sup>(1)</sup> This test is performed with the terminal in the off-state condition.

<sup>(2)</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested at  $V_{CC} = 0 \text{ V}$ .

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#### **Timing Requirements**

over recommended operating free-air temperature range,  $V_{CC}$  = 3.3 V  $\pm$  0.3 V (unless otherwise noted) (see Figure 1)

	DADAMET	ED	TEST CONDITIONS	T	λ = 25°C		MIN	MAX	UNIT
	PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	IVIIIN		UNIT
_	Dulas duration	CLR		5			5		20
ı <sub>w</sub>	Pulse duration	A or B trigger		5			5		ns
	Dulas ratingger time		$R_{ext} = 1 \text{ k}\Omega, C_{ext} = 100 \text{ pF}$	(1)	76		(1)		ns
r <sub>rr</sub>	Pulse retirgger time		$R_{ext} = 1 \text{ k}\Omega, C_{ext} = 0.01 \mu\text{F}$	(1)	1.8		(1)		μs

<sup>(1)</sup> See retriggering data in the application information section.

#### **Timing Requirements**

over recommended operating free-air temperature range,  $V_{CC}$  = 5 V  $\pm$  0.5 V (unless otherwise noted) (see Figure 1)

	PARAMET	ED	TEST CONDITIONS	TA	T <sub>A</sub> = 25°C		MIN	MAX	UNIT
	FARAMEI	ER	TEST CONDITIONS	MIN	TYP	MAX	IVIIIN	WAA	UNII
	Dulas duration	CLR		5			5		20
ı <sub>w</sub>	Pulse duration	A or B trigger		5			5		ns
	Dulas ratinggar time		$R_{\text{ext}} = 1 \text{ k}\Omega, C_{\text{ext}} = 100 \text{ pF}$	(1)	59		(1)		ns
L <sub>rr</sub>	t <sub>rr</sub> Pulse retirgger time		$R_{\text{ext}} = 1 \text{ k}\Omega, C_{\text{ext}} = 0.01 \mu\text{F}$	(1)	1.5		(1)		μs

<sup>(1)</sup> See retriggering data in the application information section.

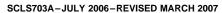
#### **Switching Characteristics**

over recommended operating free-air temperature range,  $V_{CC}$  = 3.3 V  $\pm$  0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	TEST CONDITIONS	T <sub>A</sub>	= 25°C	;	MIN	MAX	UNIT
PARAMETER	(INPUT)	(OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	IVIIIN	IVIAA	UNII
t <sub>PLH</sub>	Ā or B	Q or $\overline{\mathbb{Q}}$	C <sub>L</sub> = 15 pF		9.5 <sup>(1)</sup>	20.6(1)	1 <sup>(1)</sup>	24 <sup>(1)</sup>	20
t <sub>PHL</sub>	AUID	QUQ	C <sub>L</sub> = 15 pr	1	0.2(1)	20.6(1)	1 <sup>(1)</sup>	24 <sup>(1)</sup>	ns
t <sub>PLH</sub>	CLR	Q or Q	C <sub>L</sub> = 15 pF		7.5 <sup>(1)</sup>	15.8 <sup>(1)</sup>	1 <sup>(1)</sup>	18.5 <sup>(1)</sup>	ns
t <sub>PHL</sub>	CLK	Q 01 Q	O <sub>L</sub> = 13 pr		9.3 <sup>(1)</sup>	15.8 <sup>(1)</sup>	1 <sup>(1)</sup>	18.5 <sup>(1)</sup>	10
t <sub>PLH</sub>	CLR trigger	Q or $\overline{\mathbb{Q}}$	C <sub>L</sub> = 15 pF		10 <sup>(1)</sup>	22.4(1)	1 <sup>(1)</sup>	26 <sup>(1)</sup>	ns
t <sub>PHL</sub>	CLN trigger	Q 01 Q	O <sub>L</sub> = 13 pr	1	0.6 <sup>(1)</sup>	22.4(1)	1 <sup>(1)</sup>	26 <sup>(1)</sup>	10
t <sub>PLH</sub>	Ā or B	Q or $\overline{\mathbb{Q}}$	C <sub>L</sub> = 50 pF		10.5	24.1	1	27.5	ns
t <sub>PHL</sub>	AUB	Q 01 Q	O <sub>L</sub> = 30 pr		11.8	24.1	1	27.5	115
t <sub>PLH</sub>	CLR	Q or $\overline{Q}$ $C_1 = 50$			8.9	19.3	1	22	ns
t <sub>PHL</sub>	CLIX	Q 01 Q	$C_L = 50 \text{ pF}$		10.5	19.3	1	22	115
t <sub>PLH</sub>	CLR trigger	Q or $\overline{\mathbb{Q}}$	C <sub>L</sub> = 50 pF		11	25.9	1	29.5	ns
t <sub>PHL</sub>	CLIV trigger	Q 01 Q	O <sub>L</sub> = 30 pi		12.3	25.9	1	29.5	115
			$C_L$ = 50 pF, $C_{\text{ext}}$ = 28 $\mu$ F, $R_{\text{ext}}$ = 2 k $\Omega$		182	240		300	ns
t <sub>w</sub> (2)		Q or $\overline{\mathbb{Q}}$	$C_L$ = 50 pF, $C_{ext}$ = 0.01 $\mu$ F, $R_{ext}$ = 10 k $\Omega$	90	100	110	90	110	μs
			$C_L$ = 50 pF, $C_{ext}$ = 0.1 $\mu$ F, $R_{ext}$ = 10 $k\Omega$	0.9	1	1.1	0.9	1.1	ms
$\Delta t_w^{(3)}$					±1%				

<sup>(1)</sup> On products compliant to MIL\_PRF-38535, this parameter is not production tested.

 <sup>(2)</sup> t<sub>w</sub> = Pulse duration at Q and Q outputs
 (3) Δt<sub>w</sub> = Output pulse-duration variation (Q and Q) between circuits in same package





#### **Switching Characteristics**

over recommended operating free-air temperature range,  $V_{CC}$  = 5 V  $\pm$  0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	TEST CONDITIONS	T,	չ = 25°0	;	MIN	MAV	LINUT
PARAMETER	(INPUT)	(OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	IVIIN	MAX	UNIT
t <sub>PLH</sub>	Ā or B	Q or $\overline{\mathbb{Q}}$	C <sub>L</sub> = 15 pF		6.5 <sup>(1)</sup>	12 <sup>(1)</sup>	1 <sup>(1)</sup>	14 <sup>(1)</sup>	20
t <sub>PHL</sub>	AUID	QUIQ	C <sub>L</sub> = 15 pr		7.1 (1)	12 <sup>(1)</sup>	1 <sup>(1)</sup>	14 <sup>(1)</sup>	ns
t <sub>PLH</sub>	CLR	Q or $\overline{\mathbb{Q}}$	C <sub>L</sub> = 15 pF		5.3 <sup>(1)</sup>	9.4 <sup>(1)</sup>	1 <sup>(1)</sup>	11 <sup>(1)</sup>	ns
t <sub>PHL</sub>	CLK	QuiQ	OL = 13 pr		6.5 <sup>(1)</sup>	9.4(1)	1 <sup>(1)</sup>	11 <sup>(1)</sup>	10
t <sub>PLH</sub>	CLR trigger	Q or $\overline{\mathbb{Q}}$	C <sub>L</sub> = 15 pF		6.9 <sup>(1)</sup>	12.9 <sup>(1)</sup>	1 <sup>(1)</sup>	15 <sup>(1)</sup>	no
t <sub>PHL</sub>	CLR trigger	QUIQ	CL = 15 pr		7.4(1)	12.9 <sup>(1)</sup>	1 (1)	15 <sup>(1)</sup>	ns
t <sub>PLH</sub>	Ā or B	Q or $\overline{\mathbb{Q}}$	C _ 50 %E		7.3	14	1	16	20
t <sub>PHL</sub>	AUID	QUIQ	$C_L = 50 \text{ pF}$		8.3	14	1	16	ns
t <sub>PLH</sub>	<u>CLR</u>	Q or $\overline{\mathbb{Q}}$	C _ 50 %E		6.3	11.4	1	13	ns
t <sub>PHL</sub>	CLK	QUIQ	$C_L = 50 \text{ pF}$		7.4	11.4	1	13	
t <sub>PLH</sub>	CLR trigger	O or $\overline{\square}$	C = 50 pE		7.6	14.9	1	17	20
t <sub>PHL</sub>	CLR trigger	Q or $\overline{Q}$ $C_L = 50 \text{ pF}$			8.7	14.9	1	17	ns
			$C_L$ = 50 pF, $C_{ext}$ = 28 $\mu$ F, $R_{ext}$ = 2 k $\Omega$		167	200		240	ns
t <sub>w</sub> (2)		Q or $\overline{\mathbb{Q}}$	$C_L$ = 50 pF, $C_{ext}$ = 0.01 $\mu$ F, $R_{ext}$ = 10 k $\Omega$	90	100	110	90	110	μs
			$C_L$ = 50 pF, $C_{\text{ext}}$ = 0.1 $\mu$ F, $R_{\text{ext}}$ = 10 k $\Omega$	0.9	1	1.1	0.9	1.1	ms
$\Delta t_w^{(3)}$					±1%				

<sup>(1)</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested.

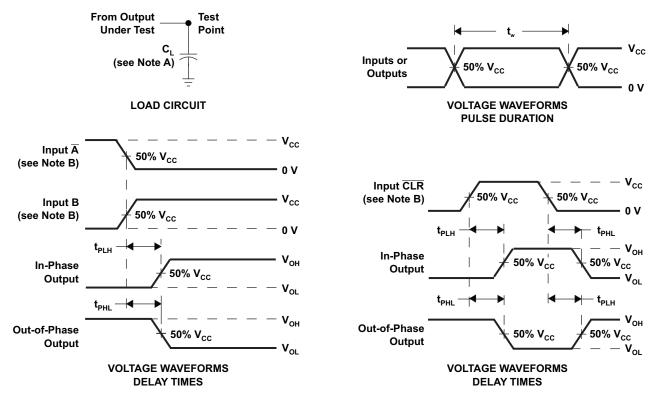
#### **Operating Characteristics**

 $V_{CC} = 5 \text{ V}, T_{A} = 25^{\circ}\text{C}$ 

	PARAMETER	TEST CONDITIONS	TYP	UNIT
$C_{pd}$	Power dissipation capacitance	No load	29	pF

 <sup>(2)</sup> t<sub>w</sub> = Pulse duration at Q and Q outputs
 (3) Δt<sub>w</sub> = Output pulse-duration variation (Q and Q) between circuits in same package

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A.  $C_L$  includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics:  $Z_{\Omega} = 50 \Omega$ ,  $t_r = 3 \text{ ns}$ ,  $t_f = 3 \text{ ns}$ .
- C. The outputs are measured one at a time, with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



#### APPLICATION INFORMATION

#### **Caution in Use**

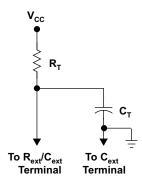
To prevent malfunctions due to noise, connect a high-frequency capacitor between  $V_{CC}$  and GND, and keep the wiring between the external components and  $C_{ext}$  and  $R_{ext}/C_{ext}$  terminals as short as possible.

#### **Powerdown Considerations**

Large values of  $C_{ext}$  can cause problems when powering down the SN74AHC123A devices because of the amount of energy stored in the capacitor. When a system containing this device is powered down, the capacitor can discharge from  $V_{CC}$  through the protection diodes at pin 2 or pin 14. Current through the input protection diodes must be limited to 30 mA; therefore, the turn-off time of the  $V_{CC}$  power supply must not be faster than  $t = V_{CC} \times C_{ext}/30$  mA. For example, if  $V_{CC} = 5$  V and  $C_{ext} = 15$  pF, the  $V_{CC}$  supply must turn off no faster than  $t = (5 \text{ V}) \times (15 \text{ pF})/30$  mA = 2.5 ns. Usually, this is not a problem because power supplies are heavily filtered and cannot discharge at this rate. When a more rapid decrease of  $V_{CC}$  to zero occurs, the SN74AHC123A can sustain damage. To avoid this possibility, use external clamping diodes.

#### **Output Pulse Duration**

The output pulse duration  $(t_w)$  is determined primarily by the values of the external capacitance  $(C_T)$  and timing resistance  $(R_T)$ . The timing components are connected as shown in Figure 2.



**Figure 2. Timing-Component Connections** 

The pulse duration is given by:

$$t_{w} = K \times R_{T} \times C_{T} \tag{1}$$

if  $C_T$  is  $\geq 1000$  pF, K = 1 or

if C<sub>T</sub> is < 1000 pF, K can be determined from Figure 9

where:

t<sub>w</sub> = pulse duration in ns

 $R_T$  = external timing resistance in  $k\Omega$ 

C<sub>T</sub> = external capacitance in pF

K = multiplier factor

Equation 1 and Figure 3 can be used to determine values for pulse duration, external resistance, and external capacitance.

#### **APPLICATION INFORMATION (continued)**

#### **Retriggering Data**

NOTE: Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.

The minimum input retriggering time ( $t_{MIR}$ ) is the minimum time required after the initial signal before retriggering the input. After  $t_{MIR}$ , the device retriggers the output. Experimentally, it also can be shown that to retrigger the output pulse, the two adjacent input signals should be  $t_{MIR}$  apart, where  $t_{MIR} = 0.3 \times t_{w}$ . The retrigger pulse duration is calculated as shown in Figure 3.

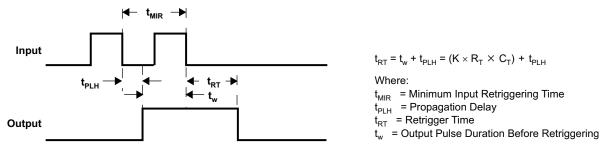
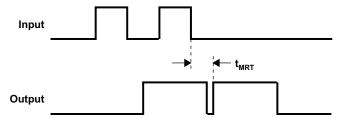


Figure 3. Retrigger Pulse Duration

The minimum value from the end of the input pulse to the beginning of the retriggered output should be approximately 15 ns to ensure a retriggered output (see Figure 4).



 $t_{MRT}$  = Minimum Time Between the End of the Second Input Pulse and the Beginning of the Retriggered Output  $t_{MRT}$  = 15 ns

Figure 4. Input/Output Requirements



#### **APPLICATION INFORMATION (continued)**

NOTE: Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.

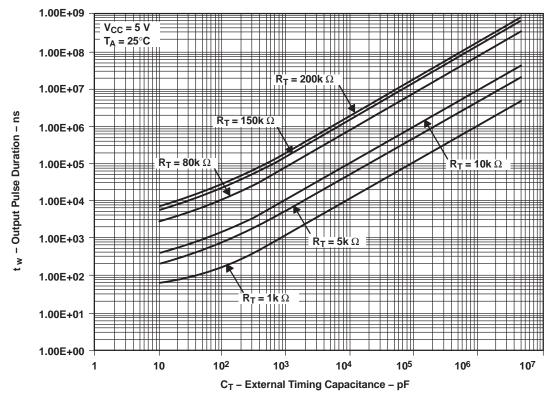


Figure 5. Output Pulse Duration vs External Timing Capacitance

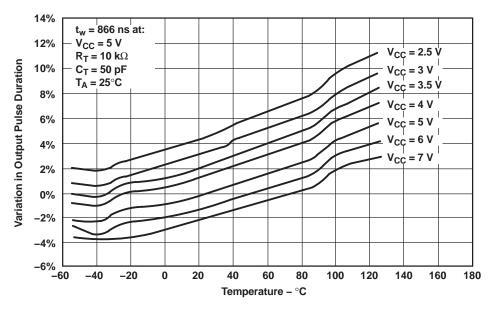
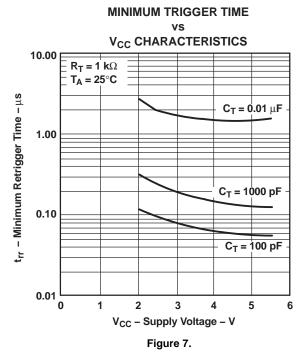


Figure 6. Variations in Output Pulse Duration vs Temperature

#### **APPLICATION INFORMATION (continued)**

NOTE: Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.



## EXTERNAL CAPACITANCE VALUE

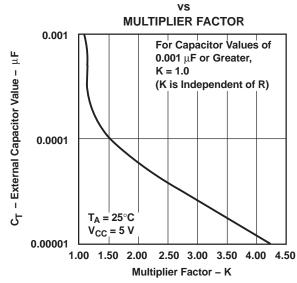


Figure 9.

# OUTPUT PULSE-DURATION CONSTANT vs SUPPLY VOLTAGE

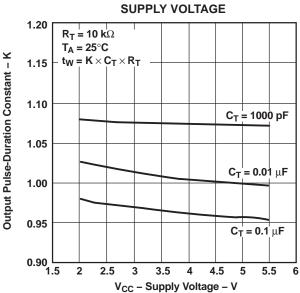


Figure 8.

# DISTRIBUTION OF UNITS vs

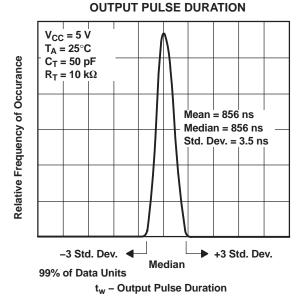


Figure 10.



### PACKAGE OPTION ADDENDUM

10-Dec-2020

#### **PACKAGING INFORMATION**

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
							(6)				
SN74AHC123AMDREP	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AHC123AEP	Samples
SN74AHC123AMDREPG4	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AHC123AEP	Samples
V62/06665-01XE	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AHC123AEP	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## **PACKAGE OPTION ADDENDUM**

10-Dec-2020

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

#### OTHER QUALIFIED VERSIONS OF SN74AHC123A-EP:

• Military: SN54AHC123A

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications

## **PACKAGE MATERIALS INFORMATION**

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#### TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

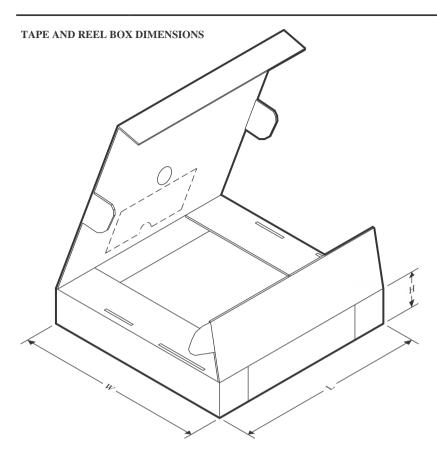
#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	U	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74AHC123AMDREP	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1

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#### \*All dimensions are nominal

Device		Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
ı	SN74AHC123AMDREP	SOIC	D	16	2500	353.0	353.0	32.0	

## D (R-PDS0-G16)

#### PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



## D (R-PDSO-G16)

## PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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